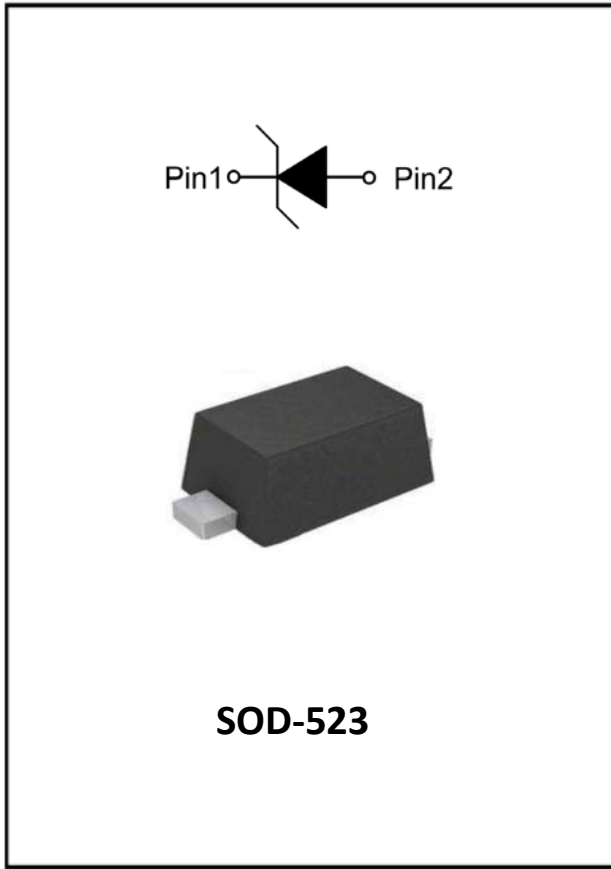


1- Line, Uni-directional, Transient Voltage Suppressor



Features

- Stand-off voltage: 6 V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 10A (8/20 μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

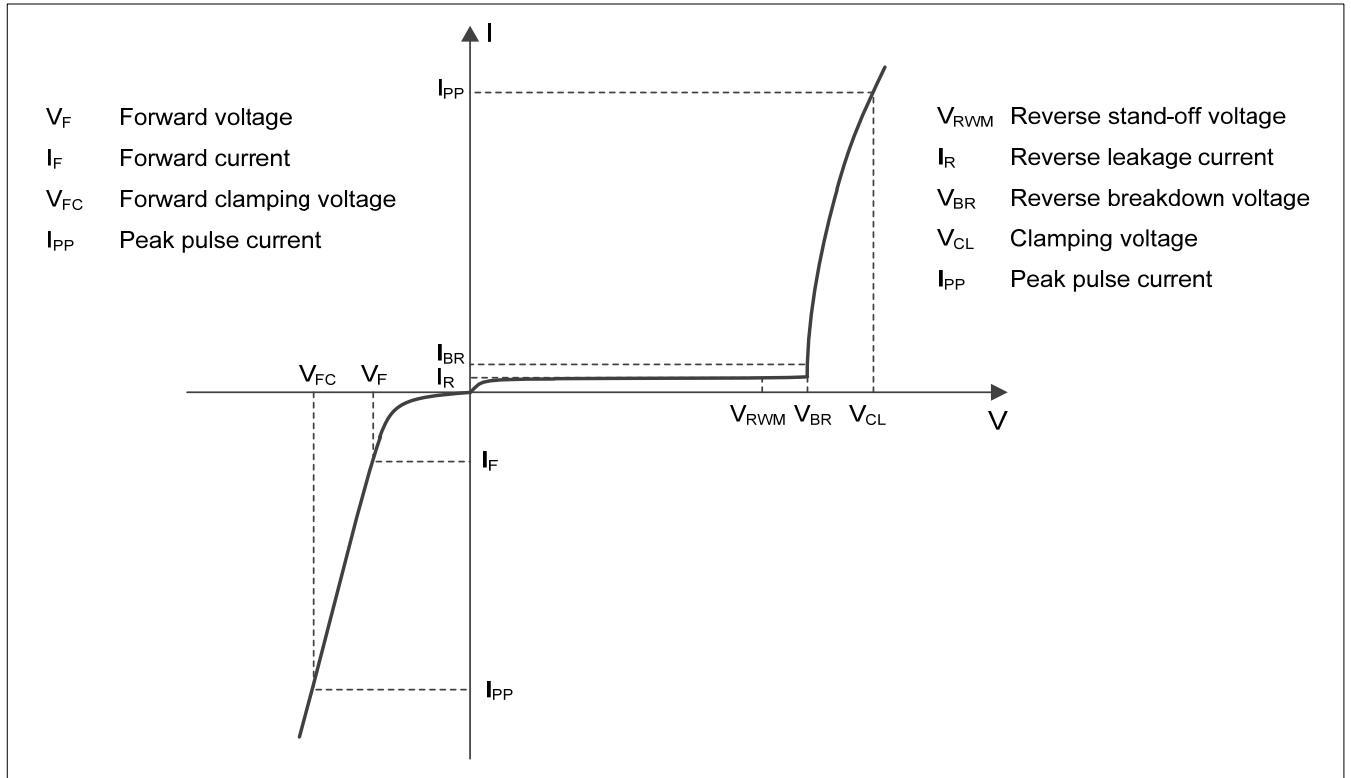
- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Portable electronics
- SIM card protection
- High-speed data lines

Mechanical Data

- Package: SOD-523
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics





ESD6V0D5

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	180	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{pp}	10	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	-55~125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				6
Reverse leakage current	I_R	μA	$V_{RWM} = 6V$			0.01
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	6.8		
Clamping voltage ²⁾	V_{CL}	V	$I_{PP} = 5A, t_p = 8/20\mu s$		9.3	13
		V	$I_{PP} = 10A, t_p = 8/20\mu s$		10.9	18
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		68	

Notes:

- (1). TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
- (2). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD6V0D5	F2	Approximate 2	8000	80000	320000	7" reel



■ Characteristics (Typical)

Fig.1 8/20 μ s waveform per IEC61000-4-5

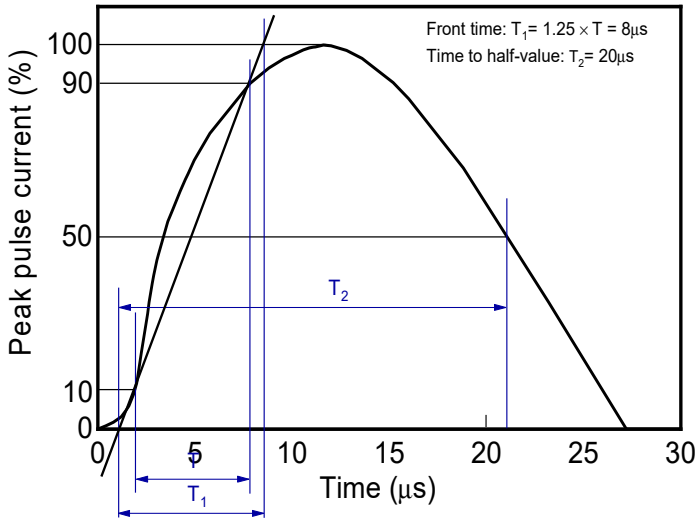


Fig.2 Contact discharge current waveform per IEC61000-4-2

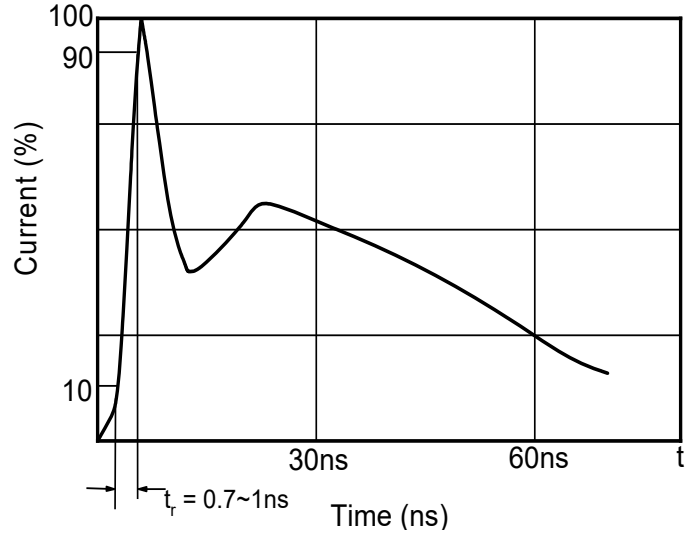


Fig.3 Clamping voltage vs. Peak pulse current

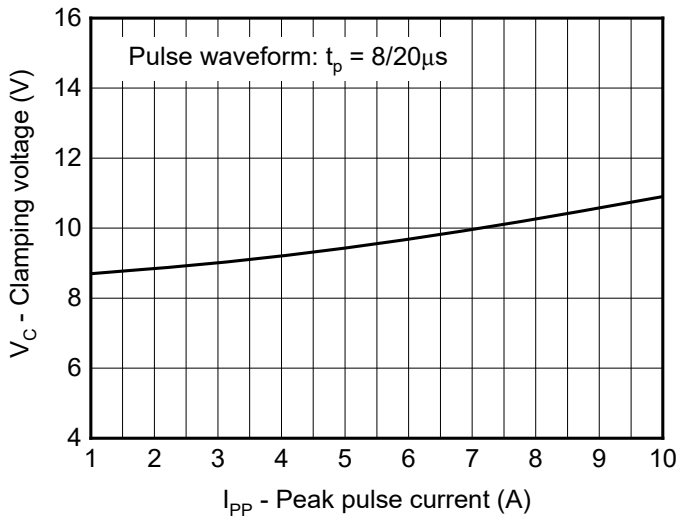


Fig.4 Capacitance vs. Reverse voltage

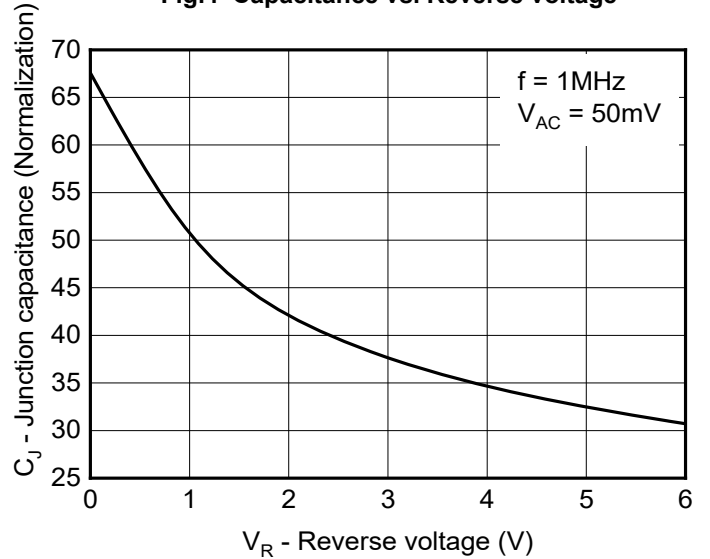


Fig.5 Non-repetitive peak pulse power vs. Pulse time

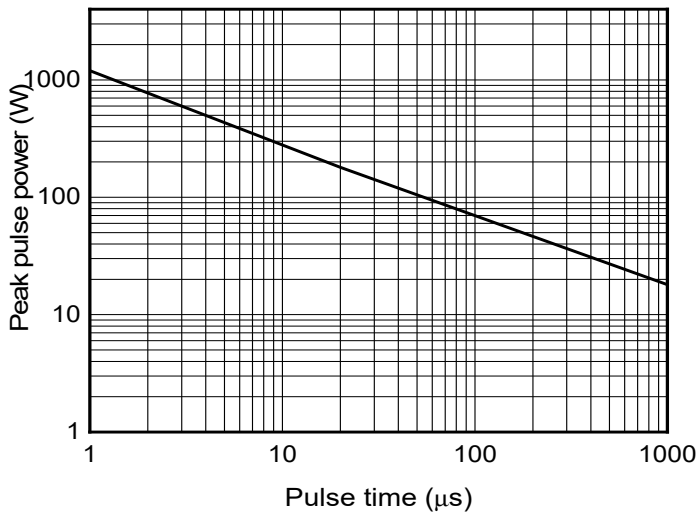


Fig.6 Power derating vs. Ambient temperature

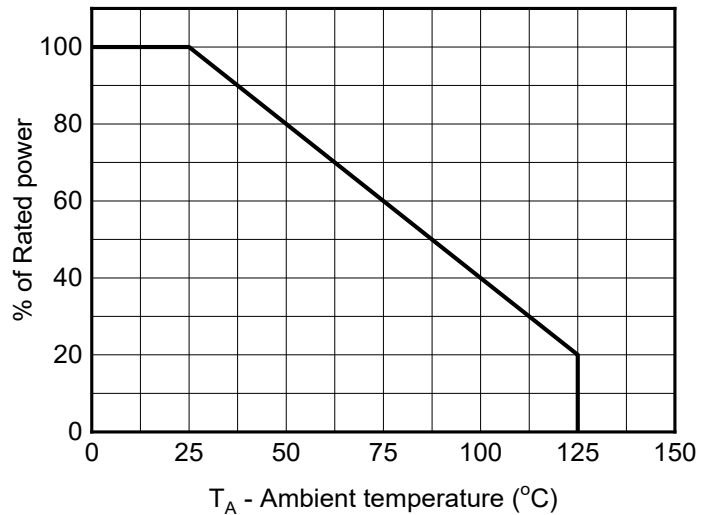
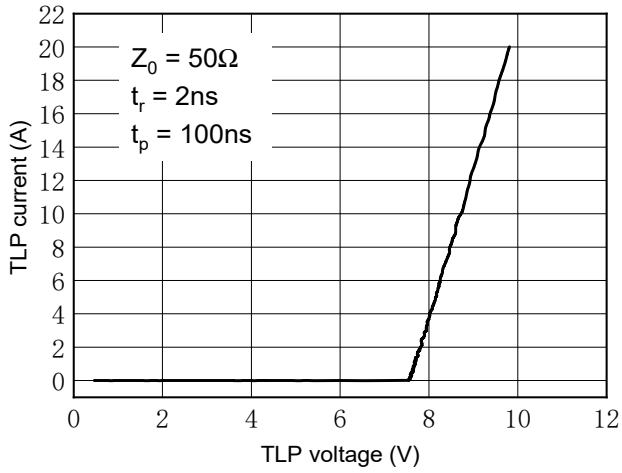
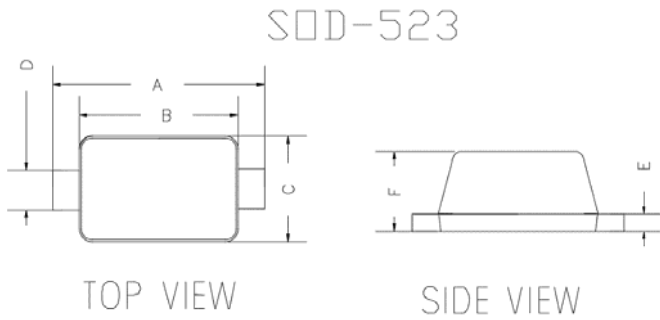


Fig.9 TLP Measurement

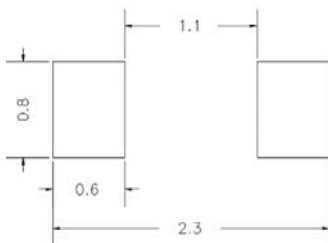


■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.059	0.067	1.500	1.700
B	0.043	0.051	1.100	1.300
C	0.028	0.035	0.700	0.900
D	0.010	0.014	0.250	0.350
E	0.002	0.008	0.050	0.200
F	0.020	0.028	0.500	0.700

■ Soldering Footprint



UNIT : mm

SUGGESTED SOLDER PAD LAYOUT



ESD6V0D5

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